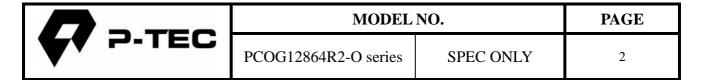


PRODUCT SPECIFICATION

Part Number

PCOG12864R2-O Series

CUSTOMER	
CUSTOMER PART NUMBER	
DESCRIPTION	
APPROVED BY	
DATE	



No.	Contents	Page
1	Part number breakdown	4
2	Functions & features	5
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Rev.	Comments	Page	Date
1	Preliminary Specification was first issued.	All	8/8'14

	MODI	EL NO.	PAGE
P-TEC	PCOG12864R2-O serie	s SPEC ONLY	4
1 <u>. Part number</u>	breakdown		
P 1 2 3 4 Replace each Space ()		and or numbers	
1. P-tec LCD Type	C = Character C G = Graphic TA	OF = Chip On Flex AB = Tape Automated Bor T = Thin-film Transistor	nding
2. LCD Model	Example for Character: 200 Example for Graphic: 12864	side and 116mm x 37 overall size	x 12.7mm Dots per Column
3. Fluid Type	Y = STN/Yellow Green	8 = STN/ Blue F = FSTN/ White N = FSTN/ Black	
4. Backlight/polorizer	NM= None/Transmissive NR=None/Reflective	LF= LED/Transflective LM= LED/Transmissive CF= CCFL/Transflective CM=CCFL=Transmissive	
5. Backlight Color	Y = Yellow	ove on to viewing angle [S = Yellow/Green O = Orange W = White	6.])
6. Viewing Angle	D = 6:00 U = 12:00	R = 3:00 L = 9:00	
7. Internal Number	Single Letter for internal pur	ooses	
8. Extended Temperature	This space is blank if operati An X will be visible if the LCE		
9. Customer Specials or List of Value-added items	Usually blank unless custom Can be several Letters long		ations.

	MODEL	NO.	PAGE
P-TEC	PCOG12864R2-O series	SPEC ONLY	5
3.2. Viewing area : 3 3.3. Dot pitch : 0 3.4. Dot size : 0	: 128x64 Dots : FSTN / Positive/ Tran : 6 o'clock : 1/65 Duty cycle, 1/9) : 3.0V : 9.0V (Reference volta : -20~70°C : -30~80°C : Edge White ECIFICATIONS 5.0mm (L)*40.0+50.0(FPC)mm (W 7.0mm (L)*28.0mm (W) .282mm (L)*0.36mm (W) .252mm (L)*0.33mm (W) Approx.	Bias age)	
COM31 COM0	128x64 DOTS	COM63 COM32 COM32	
COMO E	ST7565R	COM63	
3	32	1	

Figure 1.Block diagram



PCOG12864R2-O series

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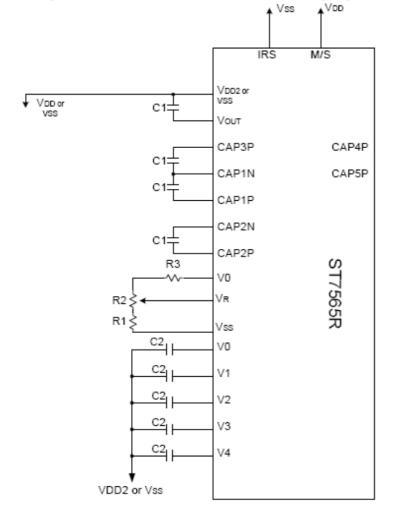
5. DIMENSIONAL OUTLINE -0.282 DOT SIZE SCALE 10:1 Specification: 1) Driving: Dtty: 1/65, Bias:1/9, VLCD:9.0V(Ref), VDD:3.0V 2) Vrewing angle: 6 O'clock 3) Disploy mode: FSIN/Positive/Transfrective 4) Operating terms: -20°C-+70°C 5) Corrage terms: -20°C-+80°C 5) C: ST7565R(or compatible) 6) Booklight: EDCE White (4 Diss. //F60mA, .//=3.1±0.2V) 7) Dimensions with mork "* are important, with mork "0" are referenced 8). All the raw materials are RoHS compliant ł 4 0.36 _ -0.33 254 2-7.0 10,40 -CONTACT SIDE 2-4.0 -2-1.50 LBLACK TAPE *7.20±0.3 -0.70±0.1 1.30-0.60-2.00 0.3±0.05 ŧ *2.05MAX(LCD)-+ 0.70±0.1-FRONT FPC STIFFENER SILICONE *40.00(B/L)±0.3 *50.00±1.0 1.00 38.00±0.2(LCD) 32.00 (6.00) CAP3+ 10.40 32 /CS1 1628.00(V.A) 2.90 1.50 ----0.70 -1.70 0.50 5.395 23.01(A.A) CAP2+ CAP1+ CAP1-31 /RES 15 11 -(14.25) 14 30 A0 DOTS 32 4.80 4 DIRECTION RD(E) WR(RW) 29 *16.50±0.2 -+-13 *45.00(B/L)±0.3 43.00±0.2(LCD) - 37.00(V.A) --- 36.066(A.A) ----128X64 35.00 -39.00 -46.60 -CAP4+ CAP2-12 28 VIEWING -2-2.00 Π 27 D0 -6.00±0.5 10 ٧4 26 D1 4 4.00 ٢ V3 D2 6 7.20 0.80 PORT-*1.70-8-1-8 24 D3 -0.90 0.45 -P0.5*31=15.50±0.1 23 D4 0 Γ1 -F - Î 0.45 -6 D5 D5 SEG127 BACK VIEW COM32 COM&SEG LAYOUT COM63 5 21 D6 128*64D0TS C86 20 D7 43.20 ST7565R 4 PSB 19 VDD co COMO COM31 0.50±0.1 SEGO -0.45 2 HPMB \leq 3.00±0.5-18 VSS ŀ VOUT IRS 17 38.20 - 0.90 CONNECTOR CONNECTOR - 0.45 PIN PIN



6. LCD Driving voltage generator and bias reference circuit

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When the voltage regulator internal resistor is not used. (Example where VDD2=VDD, with 4× step-up)



Item	Set value	units
c1	1.0 to 4.7	uF
c2	0.1 to 4.7	uF

C1 and C2 are determined by the size of the LCD being driven

* 1. Because the VR terminal input impedance is high, use short leads and shielded lines.

* 2. C1 and C2 are determined by the size of the LCD being driven. Select a value that will stabilize the liquid crystal drive voltage.

Example of the Process by which to Determine the Settings:

. Turn the voltage regulator circuit and voltage follower circuit ON and supply a voltage to VOUT from the outside.

 Determine C2 by displaying an LCD pattern with a heavy load (such as horizontal stripes) and selecting a C2 that stabilizes the liquid crystal drive voltages (Vo to V4). Note that all C2 capacitors must have the same capacitance value.

Next turn all the power supplies ON and determine C1.



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<u>7. PIN</u>	DESCRIPTIO	<u>DN</u>
1	IRS	This terminal selects the resistors for the V0 voltage level adjustment. IRS = "H", Use the internal resistors IRS = "L", Do not use the internal resistors
2	HPMB	This is the power control terminal for the power supply circuit for liquid crystal drive. /HPM = "H": Normal mode /HPM = "L": High power mode (suggested)
3	PSB	This is the parallel data input/4-line SPI data input switch terminal. P/S = "H": Parallel data input. P/S = "L": 4-line SPI data input.
4	C86	This is the MPU interface switch terminal C86 = "H": 6800 Series MPU interface C86 = "L": 8080 Series MPU interface
5	VR	Voltage adjustment pad. Applies voltage between V0 and VSS using a resistive divider.
6~10	V0,V1,V2,V3,V4	LCD driver supplies voltages.
	CAP4+, CAP2-,	
11~16	CAP2+, CAP1+,	DC/DC voltage converter.
	CAP1-, CAP3+	
17	VOUT	DC/DC voltage converter. Connect a capacitor between this terminal and VSS or VDD
18	VSS	Power ground
19	VDD	Power supply for logic(+3.0V)
20~27	D7~D0	Data bus lines
28	RD(E)	Enable signal
29	WR(RW)	Write signal
30	A0	This is connected to the least significant bit of the normal MPU address bus, and it determines whether the data bits are data or a command
31	/RES	The RESET signal
32	/CS1	This is the chip select signal



SPEC ONLY

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8. MAXIMUM ABSOUTE LIMIT

Maximum Ratings (Voltage Reference to VSS)(for IC)

Unless otherwise noted, Vss = 0V

Table 17						
Pa	rameter	Symbol	Conditions	Unit		
Power Supply Voltage		VDD	-0.3 ~ 3.6	V		
Power supply voltage (\	/DD standard)	VDD2	-0.3 ~ 3.6	V		
Power supply voltage (VDD standard)		V0, VOUT	-0.3 ~ 13.5	V		
Power supply voltage (VDD standard)		V1, V2, V3, V4	-0.3 to V0	V		
Operating temperature		Topr	-30 to +85	°C		
Storage temperature	Bare chip	Tstr	-65 to +150	°C		

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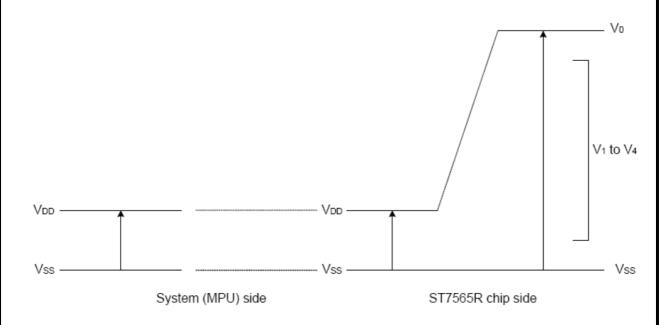


Figure 30

Notes and Cautions

- The VDD2, V0 to V4 and VOUT are relative to the Vss = 0V reference.
 Insure that the voltage levels of V1, V2, V3, and V4 are always such that VOUT ≥ V0 ≥ V1 ≥ V2 ≥ V3 ≥ V4.
- 3. Permanent damage to the LSI may result if the LSI is used outside of the absolute maximum ratings. Moreover, it is recommended that in normal operation the chip be used at the electrical characteristic conditions, and use of the LSI outside of these conditions may not only result in malfunctions of the LSI, but may have a negative impact on the LSI



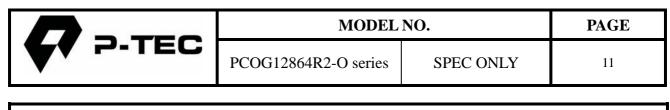
PCOG12864R2-O series

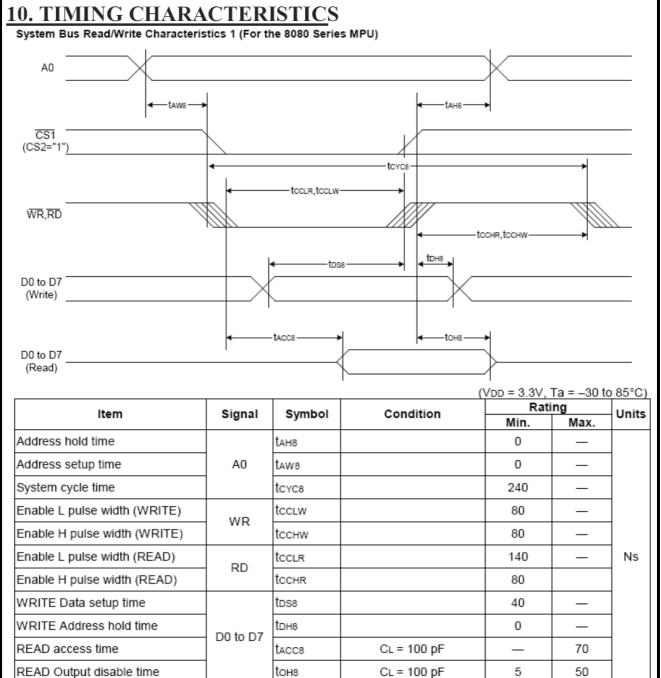
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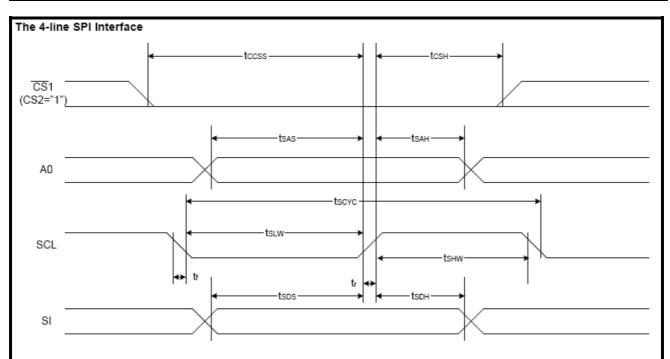
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Item		m		Symbol	6.0	ndition		Rating		Units	Applicable		
	ite	an)	3	synbol		anduon	Min.	Тур.	Max.	onits	Pin		
	Operating	Voltage (1)		VDD			1.8	—	3.3	v	Vss*1		
	Operating '	Voltage (2)		VDD2	2 (Relative to Vss)		2.4	_	3.3	v	Vss		
ŀ	ligh-level Ir	nput Voltage		VIHC			0.8 x VDD	_	VDD	V	*3		
l	ow-level In	put Voltage		VILC			Vss	_	0.2 x Vdd	V	*3		
Н	igh-level Oı	utput Voltage	Э	Vонс	Іон = -0.5	i mA	0.8 x Vdd		VDD	V	*4		
Ŀ	ow-level Ou	itput Voltage	;	Volc	loL = 0.5 r	nA	Vss		0.2 x Vdd	V	*4		
	Input leaka	age current		lu	VIN = VDD	or Vss	-1.0	_	1.0	μA	*5		
(Output leak	age current	it ILO		VIN = VDD		-3.0	—	3.0	μA	*6		
L	Liquid Crystal Driver ON Resistance		Liquid Crystal Driver ON			Ron	Ta = 25°C (Relative	Vo = 13.0 V	_	2.0	3.5	κΩ	SEGn
				RON	To VDD)	Vo = 8.0 V	_	3.2	5.4	N32	COMn *7		
Static Consumption Current		nt	Issq	Vo = 13.0	v	_	0.01	2	μA	VDD, VDD2			
C	Output Leak	age Current		15Q	(Relative To VDD)		_	0.01	10	μA	V0		
Inp	out Termina	I Capacitano	:e	CIN	Ta = 25°C	, f = 1 MHz	_	5.0	8.0	pF			
		Internal Oscillato	r	fosc	1/65 duty Ta - 25%C		17	20	24	kHz	*8		
C	scillator	External Input		fcL	1/33 duty			20	24	kHz	CL		
Fr	requency	Internal Oscillato	r	fosc	1/49 duty 1/53 duty	1/49 duty		30	35	kHz	*8		
		External Input		fcL	1/55 duty		25	30	35	kHz	CL		
	Item	ı	Sym	bol	Con	dition	Rating		Units	Applicable			
		voltage	VDD		lative To V		Min. 2.4	Тур.	Max. 3.3	v	Pin Vss		
	Supply Ste	p-up output	Vol		lative To V	-			13.5	v	VOUT		
Voltage Circuit Voltage regulator		Vou				6.0	-	13.5	v	Vout			
Voltage Voltage Follower Circuit Operating V0 Voltage) (Re	Relative To Vss)		4.0	-	13.5	v	V0*9			
		Voltage	VR		a = 25°C, (Relative To Vss) 0.05%/°C		2.07	2.10	2.13	v	*10		



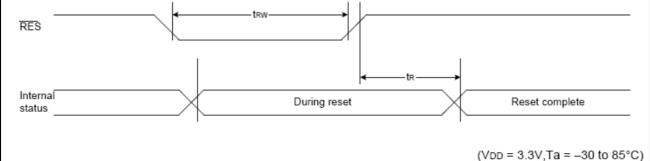


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		,		(VDD = 3.3V)		0 85°C)
Item	Signal	Symbol	Condition	Rati	Units	
	orginal	Cymbol	oonanon	Min.	Max.	011113
4-line SPI Clock Period		Tscyc		50	—	
SCL "H" pulse width	SCL	Tshw		25	—	
SCL "L" pulse width		Tslw		25	—]
Address setup time	A0	Tsas		20	-	
Address hold time	AU	Tsah		10	—	ns
Data setup time	SI	Tsds		20	—	
Data hold time	51	Тѕрн		10	—	
CS-SCL time	CS	Tcss		20	_	
CS-SCL time	03	Tcsh		40	_	

11. Reset Timing



Itom	Signal Symbo	Symbol	mbol Condition		Units		
Item	Signal	Symbol	Condition	Min.	Тур.	Max.	Units
Reset time		tr		—		1.0	us
Reset "L" pulse width	/RES	trw		1.0	Ι		us



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Command	Command Code								Function				
Command	A0	/RD	/WR				D4				-	0	
1) Display ON/OFF	0	1	0	1	0	1	0	1	1	1) 1	LCD display ON/OFF 0: OFF, 1: ON
2) Display start line set		1	0	0	. 1		Displ	lay st	art a	ddres	SS		Sets the display RAM display start line address
Page address set	0	1	0	1	0	1	1	P	age a	addre	ess		Sets the display RAM page address
(4) Column address set upper bit Column address set lower bit	0	1	0	0 0	0 0	0 0	1 0	co Le	ost si lumn ast si lumn	add ignifi	ress can	s nt	Sets the most significant 4 bits of the displa RAM column address. Sets the least significant 4 bits of the displa RAM column address.
(5) Status read	0	0	1		Sta	itus		0	0	0	. (D	Reads the status data
(6) Display data write	1	1	0					W	rite d	ata			Writes to the display RAM
(7) Display data read	1	0	1					Re	ad d	ata			Reads from the display RAM
8) ADC select	0	1	0	1	0	1	0	0	0	0) 1	Sets the display RAM address SEG output correspondence
9) Display normal/ reverse	0	1	0	1	0	1	0	0	1	1	())	0: normal, 1: reverse Sets the LCD display normal/ reverse 0: normal, 1: reverse
(10) Display all points ON/OFF	0	1	0	1	0	1	0	0	1	0)	Display all points 0: normal display 1: all points ON
(11) LCD bias set	0	1	0	1	0	1	0	0	0	1		D	Sets the LCD drive voltage bias ratio 0: 1/9 bias, 1: 1/7 bias (ST7565R)
(12) Read/modify/write	0	1	0	1	1	1	0	0	0	0	0	D	Column address increment At write: +1 At read: 0
(13) End	0	1	0	1	1	1	0	1	1	1	(D	Clear read/modify/write
(14) Reset	0	1	0	1	. 1	1	0	0	0	1	(D	Internal reset
(15) Common output mode select	0	1	0	1	1	0	0	0 1	*	*	8	*	Select COM output scan direction 0: normal direction 1: reverse direction
(16) Power control set	0	1	0	0	0	1	0	1		pera mod	-		Select internal power supply operating mo
(17) Vo voltage regulator internal resistor ratio set	0	1	0	0	0	1	0	0	Res	sistor	rat	io	Select internal resistor ratio(Rb/Ra) mode
(18) Electronic volume mode set Electronic volume	0	1	0	1	0	0	0	0	0			1	Set the V₀ output voltage electronic volume register
register set				0	0	E	Electro	onic v	/olum	ie va	lue		
(19) Static indicator ON/OFF Static indicator	0	1	0	1	0	1	0	1	1	0) 1	0: OFF, 1: ON
register set				0	0	0	0	0	0	0	Мо	de	
(20) Booster ratio set	0	1	0	1	1	1	1	1	0	0 ste) ep-u	מ	select booster ratio 00: 2x,3x,4x 01: 5x
(21) Power save	0	1	0	0	0	0	0	0	0		alue		11: 6x Display OFF and display all
(21) Power save	-				•	•							points ON compound command
(22) NOP	0	1	0	1	1	1	0	0	0	1	-		Command for non-operation
23) Test	0	1	0	1	1	1	1	*	*	*	,		Command for IC test. Do not use this command



13. BACK LIGHT CHARACTERISTICS

LCD Module with Side LED Backlight **ELECTRICAL RATINGS**

	$Ta = 25^{\circ}C$							
Item	Symbol	Condition	Min	Тур	Max	Unit		
Forward Voltage	VF	IF=60mA	2.9	3.1	3.3	V		
Reverse Current	IR	VR=0.8V		15		mA		
Luminance(without LCD)	Lv	IF=60mA	420	500		Cd/m^2		
Color coordinate(without LCD)	λp IF=60mA		X=0.26 Y=0.27		X=0.30 Y=0.31			
Color	white							

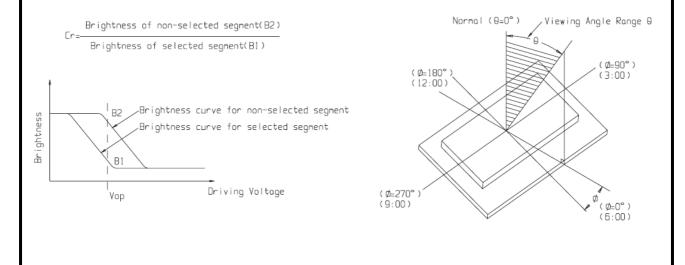
Note:

when the temperature exceed 25° C, the approved current decrease rate for Backlight change as the temperature increase is: -0.36mA/°C (below 25° C, the current refer to constant, which would not change with temperature).

14. ELECTRO-OPTICAL CHARACTERISTICS

 $(VDD=3.0V, Ta = 25^{\circ}C)$

Item	Symbol	Condition	Min	Тур	Max	Unit
Operating Voltage for LCD		$Ta = -20^{\circ}C$	9.2	9.5	9.8	
	Vop	$Ta = 25^{\circ}C$	8.7	9.0	9.2	V
		$Ta = 70^{\circ}C$	8.2	8.5	8.8	
D agnonga tima	Tr	$Ta = 25^{\circ}C$		200	400	ms
Response time	Tf	1a - 25 C		250	500	ms
Contrast	Cr	$Ta = 25^{\circ}C$		4.0		
Viewing angle range	θ	Cr≥2	-40		+40	deg
	?	Cr≥2	-40		+40	deg





15. PRECAUTION FOR USING LCD/LCM

After reliability test, recovery time should be 24 hours minimum. Moreover, functions,

performance and appearance shall be free from remarkable deterioration within 50,000

hours(average) under ordinary operating and storage conditions room temperature (20 ± 8 ?C), normal humidity (below 65% RH), and in the area not exposed to direct sun light. Using LCM beyond these conditions will shorten the life time.

Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any

alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting P-tec Corp.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or

twisting. Elastomer contacts are very delicate and missing pixels could result from slight

dislocation of any of the elements.

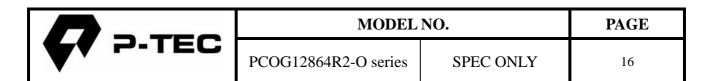
6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and

lose contact, resulting in missing pixels and also cause rainbow on the display.

7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.



- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature:350?C±10?C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40?C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

P-tec Corp LCDs and modules are not consumer products, but may be incorporated by P-tec Corp's customers into consumer products or components thereof, P-tec Corp does not warrant that its LCDs and components are fit for any such particular purpose.

- The liability of P-tec Corp is limited to repair or replacement on the terms set forth below. be responsible for any subsequent or consequential events or injury or damage to any personnel P-tec Corp will not or user including third party personnel and/or user. Unless otherwise agreed in writing between P-tec Corp and the customer, P-tec Corp will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with P-tec Corp general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.